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Unit: mm

TOSHIBA Transistor Silicon NPN Epitaxial Type (PCT Process)

# HN2C01FU

#### Audio Frequency General Purpose Amplifier Applications

• Small package (dual type)

High voltage and high current : VCEO = 50V, IC = 150mA (max)

• High hfe  $\therefore$  hfe = 120 to 400

• Excellent hFE linearity :  $h_{FE} (I_C = 0.1 \text{mA}) / (I_C = 2 \text{mA})$ 

= 0.95 (typ.)

#### Absolute Maximum Ratings (Ta = 25°C) (Q1, Q2 Common)

Characteristics	Symbol	Rating	Unit	
Collector-base voltage	$V_{CBO}$	60	V	
Collector-emitter voltage	V <sub>CEO</sub>	50	V	
Emitter-base voltage	V <sub>EBO</sub>	5	٧	
Collector current	IC	150	mA	
Base current	ΙΒ	30	mA	
Collector power dissipation	P <sub>C</sub> *	200	mW	
Junction temperature	Tj	125	°C	
Storage temperature range	T <sub>stg</sub>	-55 to 125	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e.

 $2.1 \pm 0.1$  $1.25 \pm 0.1$ 0.65 $2.0\pm0.2$  $1.3\pm0.1$ 1. EMITTER 1 (E1) 2. EMITTER 2 (E2)3. BASE 2 (B2) 4. COLLECTOR 2 (C2)5. BASE 1 (B1) US6 6. COLLECTOR 1 (C1) **JEDEC** JEITA TOSHIBA 2-2J1B

Weight: 6.8 mg (typ.)

operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

### Electrical Characteristics (Ta = 25°C) (Q1, Q2 Common)

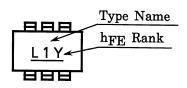
Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	_	V <sub>CB</sub> = 60V, I <sub>E</sub> = 0	_	_	0.1	μA
Emitter cut-off current	I <sub>EBO</sub>	_	$V_{EB} = 5V, I_C = 0$	I	1	0.1	μA
DC current gain	h <sub>FE</sub> (Note)	_	$V_{CE}$ = 6V, $I_C$ = 2mA	120	_	400	_
Collector-emitter saturation voltage	V <sub>CE</sub> (sat)	_	I <sub>C</sub> = 100mA, I <sub>B</sub> =10mA	_	0.1	0.25	٧
Transition frequency	f <sub>T</sub>	_	V <sub>CE</sub> = 10V, I <sub>C</sub> = 1mA	80	_	_	$MH_{Z}$
Collector output capacitance	C <sub>ob</sub>	_	$V_{CB} = 10V, I_E = 0, f = 1MH_z$	_	2	3.5	pF

Note: hFE classification

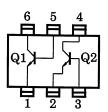
Y(Y): 120 to 240, GR(G): 200 to 400

() marking symbol

#### Marking



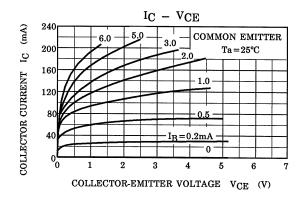
## **Equivalent Circuit (top view)**

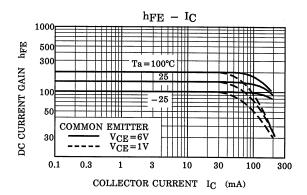


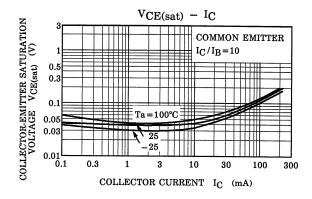
Start of commercial production 1992-01

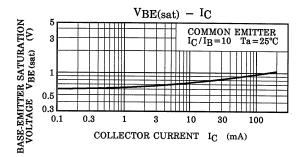
<sup>\*</sup> Total rating

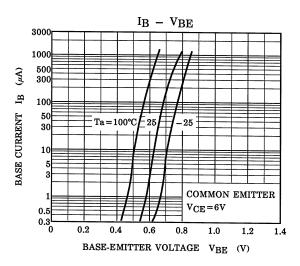
#### (Q1, Q2 Common)

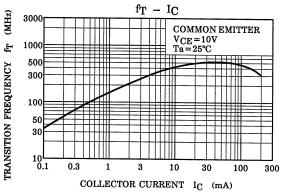


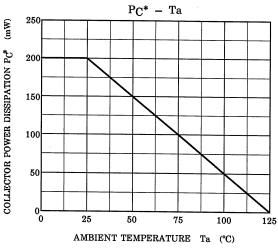












\*: Total Rating

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